

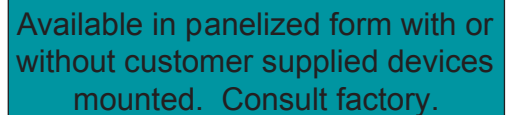


- Lead Free RoHS/WEEE Compliant.
- A cost effective means of upgrading to SOJ or SOIC...without changing your PCB layout.
- Available on .400 [10.16] and .600 [15.24] centers. Consult Data Sheet No. 18010 for adapters on .300 [7.62] centers.

- Board material is .062 thick FR406 or IS410 per IPC4101A/26 with 1 oz. Copper traces, both sides.
- Pads are finished with ENIG (Immersion Gold over Electroless Nickel)
- Pins are Brass Alloy 360 1/2 hard per UNS C36000 ASTM-B16-00.
- Pin plating is 10 μ " Min. Gold Per MIL-G-45204 over 100 μ " Min Nickel per SAE-AMS-QQ-N-290.
- Operating temperature=221°F [105°C].

- Suggested PCB hole size= $.028 \pm .002$ [$.71 \pm .05$]. dia.

All tolerances $\pm .005$ [.13]
unless otherwise specified

$$\text{"D"} = (\text{NO. OF PINS PER ROW} - 1) \times .100 \text{ [2.54]}$$


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18011RC
REV. C